

TE Internal #: 2169791-1

Ribbon Cable Connectors, Wire-to-Board, 44 Position, 2.54 mm [.1

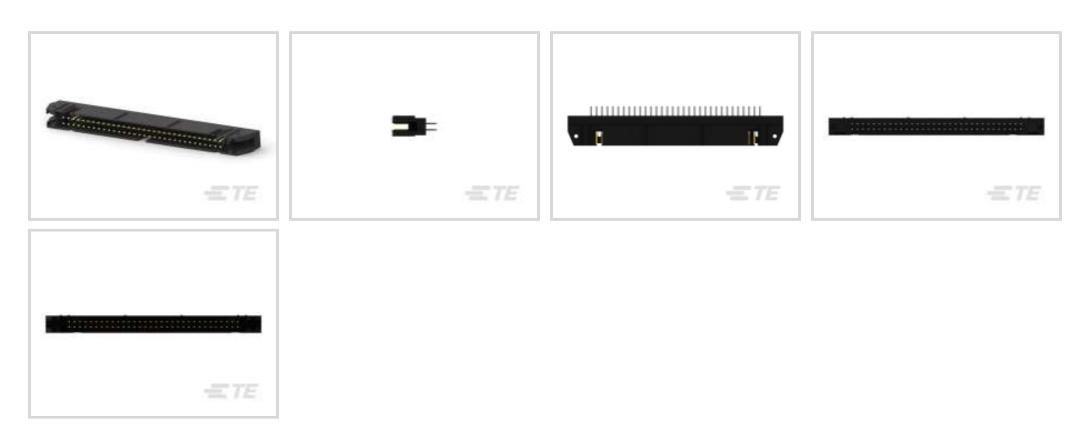
in] Centerline, Vertical, Through Hole - Press-Fit, 2 Row, Plug,

Standard Profile

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Wire-to-Board

Number of Positions: 44

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: With

PCB Mount Retention Type: Kinked

Features

Product Type Features

Product Type reatures	
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	44
PCB Mount Orientation	Vertical
Number of Rows	2
Body Features	
Connector Profile	Standard
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material	Tin

1 A

Contact Current Rating (Max)



Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
PCB Mount Retention	With
PCB Mount Retention Type	Kinked
Mating Alignment Type	Polarization
Mating Retention	With
Mating Retention Type	Ejection Latch
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	

Product Compliance

Circuit Application

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Signal

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Customers Also Bought



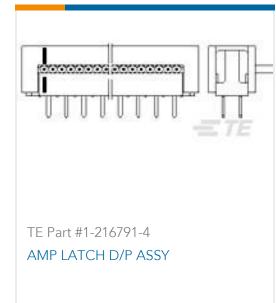
















Documents

Product Drawings

AMP-LATCH UNV HDR,44P,ACT-PIN,SEL LOAD

English

CAD Files

3D PDF

3D



Customer View Model

ENG_CVM_CVM_2169791-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2169791-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2169791-1_A.3d_stp.zip

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English

Agency Approvals

UL Report

English